

# Toppyl SP 2001 B

**Compounded Polyolefin** 

# **Product Description**

 $\label{eq:constraint} \textbf{ToppyI SP 2001 B} is a fully formulated seal peel solution especially developed for the blown film technology.$ 

This product has been designed to offer a peelable seal to PE substrates or to seal & peel against itself and is suitable for non-sterilisable applications.

Toppyl SP 2001 B is a solution created to replace completely the sealing layer in a coextruded film.

It provides a constant easy-opening force over a wide sealing temperature window and is readily processable on conventional equipment in both mono and co-extruded structures. EU and FDA compliance information about this product can be found in separate product documentation.

This product is not intended for use in medical and pharmaceutical applications.

#### **Product Characteristics** Status Commercial: Active **Test Method used** ISO $\begin{array}{l} \mbox{Medium Antiblocking , Semi Crystalline, Good Heat Seal,} \\ \mbox{Good Melt Strength , Medium Slip, Good Tear Strength} \end{array}$ Features **Typical Customer Applications** Blown Film, Peelable Film, Speciality Film **Typical Properties** Method Value Unit Physical Density ISO 1183 0.918 g/cm<sup>3</sup> Melt flow rate (MFR) ISO 1133 0.80 g/10 min Mechanical Tensile Strength @ Brk MD ASTM D 882 28 MPa Tensile Strength @ Yld MD ASTM D 882 12 MPa Elongation at break MD ASTM D 882 580 0/2

Liongation at Dieak MD	A3111 D 882	300	-70	
Thermal				
Melting temperature	DSC	113	°C	
Vicat softening temperature A/50	ISO 306	95	°C	
Film				
Coefficient of Friction	ASTM D 1894	0.25		
Note: Dynamic COF				
Secant modulus MD	ASTM D 882	200	MPa	

## Additional Properties

Recommended processing temperatures: 170°C to 230°C. In cases were higher temperatures are required please contact your appropriate technical contact for support.

### Notes

Typical properties; not to be construed as specifications.



